

RoHS Compliant

REV	MODIFICATION	DATE	DRAW
A5	Release To ECN20130304	2013.03.20	Seven
A6	Release To ECN20130315	2013.03.25	Seven
B0	Release To ECN20130511	2013.05.23	Michelle

Specification

- 1.Current Rating:2A AC/DC
- 2.Voltage Rating:100V AC
- 3.Contact Resistance:20mΩ Max.
- 4.Insulation Resistance:1000MΩ Min. At 500V
- 5.Dielectric Withstanding Voltage:AC800V/Minute
- 6.Operating Temperature:-25°C~+85°C

Material:

- 1.Housing:High Temperature Thermoplastic UL94V-0
- 2.Contact Pin:Copper Alloy SQ. Pin 0.50mm

Finish:

- 1.Housing:See P/N Option
- 2.Contact Pin:Bright Tin Plated Over Nickel.

Part No.: AD05601 XX X 4 5 2

Number Of Pin
02~16

Packing
5:Bag



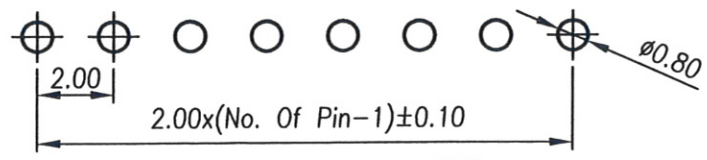
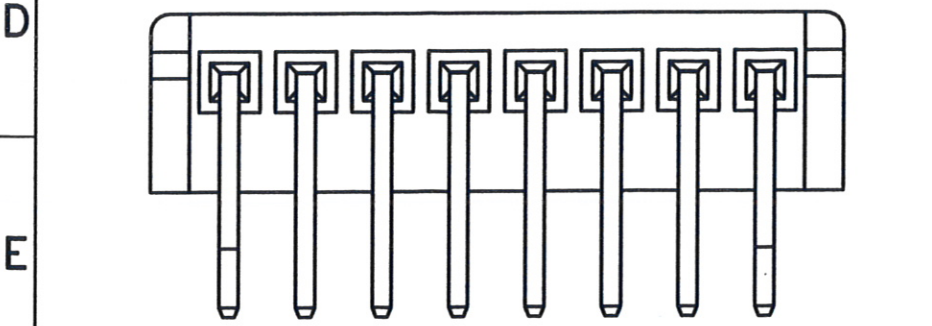
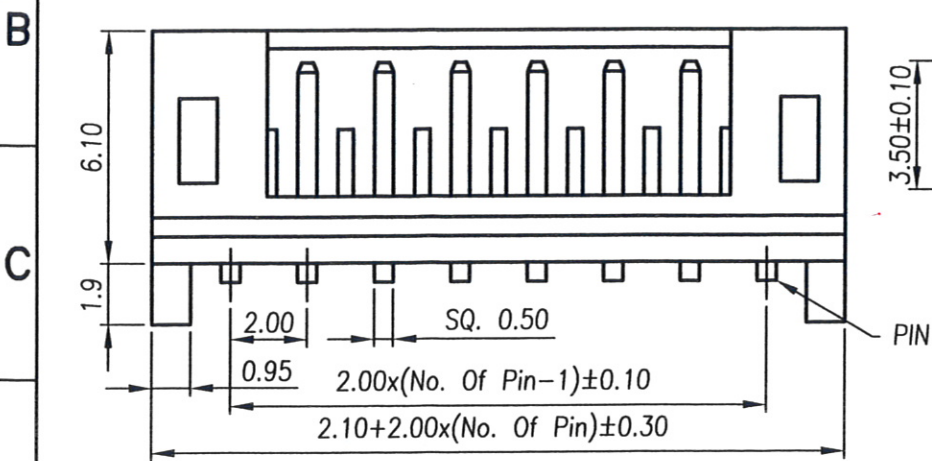
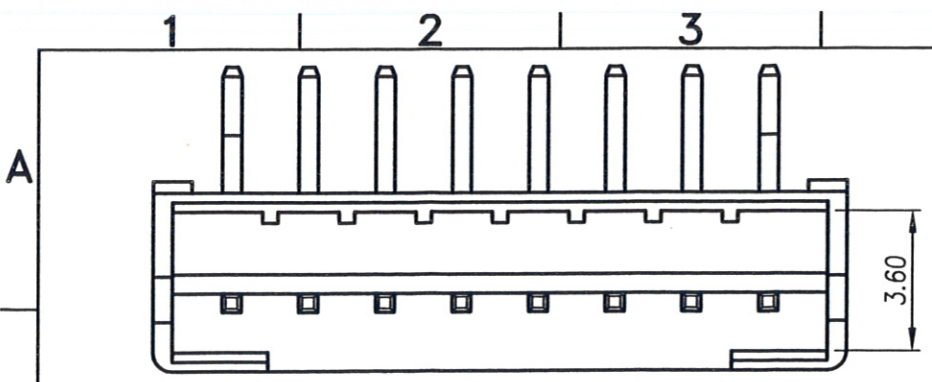
Housing Material
1~3:NY66 UL94V-0

Plating
4:Bright Tin Plated Over Nickel.
(With Kink)


1	Nature	3	Black
2	Red		

4:NY66+GF UL94V-0 Nature
5~7:NY66 UL94V-0

5	Yellow	7	Blue
6	Green		

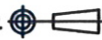


RECOMMENDED PCB LAYOUT
(TOLERANCE:±0.05)



金上達科技股份有限公司

GOLDENSUND TECHNOLOGY CO.,LTD

TOLERANCE UNLESS OTHERWISE SPECIFIED		PROJ. 	TITLE: Wire To Board Wafer 2.00mm 90° DIP			
.x± 0.35	x.* 2'	APR. Jay 20130523	PART NO. AD05601XXXX52		DWG NO. AD05601XXXX52	
.xx± 0.25	.x.* 1'	CHK. Seven 20130523	UNITS: mm	CUSTOMER DRAWING		
.xxx± 0.15	.xx.* 0.5'	DRW. Michelle 20130523	SIZE: A4	SCALE 5:1	SHEET 1 / 1	
			REV B0	V		